Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

- 1. (Original) A disk enclosure comprising:
 - a first controller powered by a first voltage circuit and coupled to a first bus;
 - a second controller powered by a second voltage circuit and coupled to a second bus; and
 - a first switch coupled between the first bus and the second bus, the first switch operable to de-couple the first and the second buses when the voltage output from the second voltage circuit falls below a predetermined threshold.
- 2. (Previously presented) The disk enclosure of claim 1, wherein the first bus is coupled to a first plurality of elements.
- 3. (Previously presented) The disk enclosure of claim 2, wherein the first plurality of elements includes at least one of a first temperature sensor, a first memory, and a first backplane controller.
- 4. (Original) The disk enclosure of claim 3, wherein the backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 5. (Previously presented) The disk enclosure of claim 3, wherein:

the first controller is coupled to a third bus;

the second controller is coupled to a fourth bus;

a second switch coupled between the third and the fourth buses, the second switch operable to de-couple the third and the fourth buses when the voltage output from the first voltage circuit falls below a predetermined threshold.

- 6. (Previously presented) The disk enclosure of claim 5, wherein the fourth bus is coupled to a second plurality of elements.
- 7. (Previously presented) The disk enclosure of claim 6, wherein the second plurality of elements includes at least one of a second temperature sensor, a second memory, and a second backplane controller.
- 8. (Previously presented) The disk enclosure of claim 7, wherein the second backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 9. (Previously presented) The disk enclosure of claim 7, wherein:

the first controller is coupled to a fifth bus;

the second controller is further coupled to a sixth bus;

a third switch coupled between the fifth bus and a seventh bus, the third switch operable to de-couple the fifth and the seventh buses when the voltage output from the first voltage circuit falls below a predetermined threshold; and

a fourth switch coupled between the sixth bus and the seventh bus, the fourth switch operable to de-couple the sixth and seventh buses when the voltage output from the second voltage circuit falls below a predetermined threshold.

- 10. (Original) The disk enclosure of claim 9, wherein the seventh bus is further coupled to a third plurality of elements.
- 11. (Previously presented) The disk enclosure of claim 10, wherein the third plurality of elements includes at least one of a third temperature sensor, a third memory, a third backplane controller, and an I/O expander.
- 12. (Original) The disk enclosure of claim 11, wherein the I/O expander is coupled to at least one battery.
- 13. (Original) The disk enclosure of claim 11, wherein the I/O expander is coupled to at least one power supply.
- 14. (Original) A disk enclosure comprising:

- a first controller powered by a first voltage circuit and coupled to a first bus;
- a second controller powered by a second voltage circuit and coupled to a second bus;
- a first switch coupled between the first bus and a third bus, the first switch operable to de-couple the first and the third buses when the voltage output from the first voltage circuit falls below a predetermined threshold; and
- a second switch coupled between the second bus and the third bus, the second switch operable to de-couple the second and the third buses when the voltage output from the first voltage circuit falls below a predetermined threshold.
- 15. (Previously presented) The disk enclosure of claim 14, wherein the third bus is coupled to a first plurality of elements.
- 16. (Original) The disk enclosure of claim 15, wherein the first plurality of elements includes at least one of a temperature sensor, a memory, a backplane controller, and an I/O expander.
- 17. (Original) The disk enclosure of claim 16, wherein the I/O expander is coupled to at least one battery.
- 18. (Original) The disk enclosure of claim 16, wherein the I/O expander is coupled to at least one power supply.
- 19. (Original) The disk enclosure of claim 15, wherein:

the first controller is coupled to a fourth bus;

the second controller is coupled to a fifth bus; and

- a third switch coupled between the fourth and the fifth buses, the third switch operable to de-couple the fourth and the fifth buses when the voltage output from the second voltage circuit falls below a predetermined threshold.
- 20. (Original) The disk enclosure of claim 19, wherein the fourth bus is coupled to a second plurality of elements.
- 21. (Original) The disk enclosure of claim 20, wherein the second plurality of elements includes at least one of a temperature sensor, a memory, and a backplane controller.

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- 22. (Original) The disk enclosure of claim 21, wherein the backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 23. (Previously presented) The disk enclosure of claim 20, wherein:

the first controller is coupled to a sixth bus;

the second controller is coupled to a seventh bus; and

- a fourth switch coupled between the sixth and the seventh buses, the fourth switch operable to de-couple the sixth and seventh buses when the voltage output from the first voltage circuit falls below a predetermined threshold.
- 24. (Original) The disk enclosure of claim 23, wherein the seventh bus is coupled to a third plurality of elements.
- 25. (Original) The disk enclosure of claim 24, wherein the third plurality of elements includes at least one of a temperature sensor, a memory, and a backplane controller.
- 26. (Original) The disk enclosure of claim 25, wherein the backplane controller is coupled to a port bypass circuit, the port bypass circuit operable to bypass a disk drive.
- 27. (New) The disk enclosure of claim 1, wherein the first and the second buses comprise I2C buses.
- 28. (New) The disk enclosure of claim 14, wherein the first, the second, and the third buses comprise I2C buses.